L	Hits	Search Text	DB	Time stamp
Number				
1	7068	guard near ring	USPAT;	2004/01/30
		,	US-PGPUB;	17:43
			EPO; JPO;	
		•	DERWENT;	
			IBM_TDB	
2	3602422	trench recess groove opening	USPAT;	2004/01/30
			US-PGPUB;	17:44
	1		EPO; JPO;	1
			DERWENT;	
1			IBM_TDB	<u> </u>
3	2682	(guard near ring) and (trench recess	USPAT;	2004/01/30
		groove opening)	US-PGPUB;	17:44
		,	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
4	1889912	substrate wafer	USPAT;	2004/01/30
			US-PGPUB;	17:44
			EPO; JPO;	
			DERWENT;	i
			IBM_TDB	1
5	1700		USPAT;	2004/01/30
		groove opening)) and (substrate wafer)	US-PGPUB;	17:45
			EPO; JPO;	
			DERWENT;	
		· ·	IBM_TDB	